16M x1Bit CMOS Dynamic RAM with Fast Page Mode

DESCRIPTION

This is a family of 16,777,216 x 1 bit Fast Page Mode CMOS DRAMs. Fast Page Mode offers high speed random access of memory cells within the same row. Power supply voltage (+5.0V or +3.3V), access time (-5 or -6), power consumption(Normal or Low power) and package type(SOJ or TSOP-II) are optional features of this family. All of this family have $\overline{CAS}$-before-$\overline{RAS}$ refresh, $\overline{RAS}$-only refresh and Hidden refresh capabilities. Furthermore, Self-refresh operation is available in L-version.

This 16Mx1 Fast Page Mode DRAM family is fabricated using Samsung′s advanced CMOS process to realize high band-width, low power consumption and high reliability. It may be used as main memory unit for high level computer and microcomputer.

FEATURES

- **Part Identification**

  - KM41C16000C/C-L (5V, 4K Ref.)
  - KM41V16000C/C-L (3.3V, 4K Ref.)

- **Active Power Dissipation**

Unit : mW

Speed	3.3V	5V
-5	324	495
-6	288	440

- **Refresh Cycles**

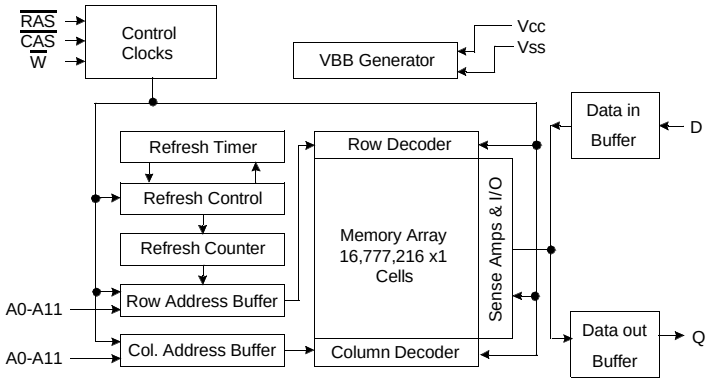
Part NO.	V_{CC}	Refresh cycle	Refresh period	
			Normal	L-ver
C16000C	5V	4K	64ms	128ms
V16000C	3.3V			

- **Performance Range**

Speed	t_{RAC}	t_{CAC}	t_{RC}	t_{PC}	Remark
-5	50ns	13ns	90ns	35ns	5V/3.3V
-6	60ns	15ns	110ns	40ns	5V/3.3V

- Fast Page Mode operation
- $\overline{CAS}$-before-$\overline{RAS}$ refresh capability
- $\overline{RAS}$-only and Hidden refresh capability
- Self-refresh capability (L-ver only)
- Fast Parallel test mode capability
- TTL(5V)/LVTTL(3.3V) compatible inputs and outputs
- Early Write Operation
- JEDEC Standard pinout
- Available in Plastic SOJ and TSOP(II) packages
- Single +5V±10% power supply (5V product)
- Single +3.3V±0.3V power supply (3.3V product)

FUNCTIONAL BLOCK DIAGRAM



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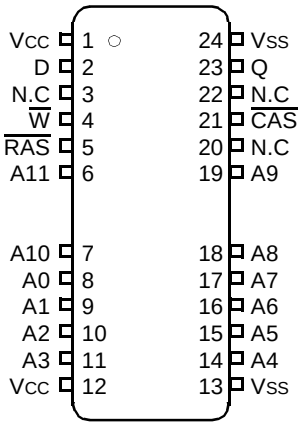
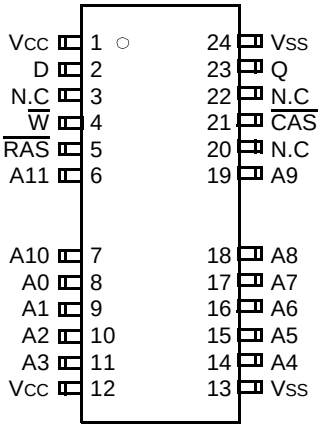
PIN CONFIGURATION (Top Views)

• **KM41C/V16000CK**



• **KM41C/V16000CS**



K:300mil 26(24) SOJ
S:300mil 26(24) TSOP II

Pin Name	Pin Function
A0 - A11	Address Inputs (4K Product)
D	Data In
Q	Data Out
Vss	Ground
$\overline{RAS}$	Row Address Strobe
$\overline{CAS}$	Column Address Strobe
$\overline{W}$	Read/Write Input
Vcc	Power(+5.0V)
	Power(+3.3V)
N.C	No Connection

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		Units
		3.3V	5V	
Voltage on any pin relative to V_{SS}	V_{IN},V_{OUT}	-0.5 to +4.6	-1.0 to +7.0	V
Voltage on V_{CC} supply relative to V_{SS}	V_{CC}	-0.5 to +4.6	-1.0 to +7.0	V
Storage Temperature	Tstg	-55 to +150	-55 to +150	°C
Power Dissipation	P_D	1	1	W
Short Circuit Output Current	I_{OS}	50	50	mA

* Permanent device damage may occur if "ABSOLUTE MAXIMUM RATINGS" are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS (Voltage referenced to Vss, T_A= 0 to 70°C)

Parameter	Symbol	3.3V			5V			Units
		Min	Typ	Max	Min	Typ	Max	
Supply Voltage	V_{CC}	3.0	3.3	3.6	4.5	5.0	5.5	V
Ground	V_{SS}	0	0	0	0	0	0	V
Input High Voltage	V_{IH}	2.0	-	V_{CC}+0.3*1	2.4	-	V_{CC}+1.0*1	V
Input Low Voltage	V_{IL}	-0.3*2	-	0.8	-1.0*2	-	0.8	V

*1 : V_{CC}+1.3V/15ns(3.3V), V_{CC}+2.0/20ns(5V), Pulse width is measured at V_{CC}

*2 : -1.3V/15ns(3.3V), -2.0/20ns(5V), Pulse width is measured at V_{SS}

DC AND OPERATING CHARACTERISTICS (Recommended operating conditions unless otherwise noted.)

Max	Parameter	Symbol	Min	Max	Units
3.3V	Input Leakage Current (Any input 0≤V_{IN}≤V_{IN}+0.3V, all other input pins not under test=0 Volt)	$I_{I(L)}$	-5	5	uA
	Output Leakage Current (Data out is disabled, 0V≤V_{OUT}≤V_{CC})	$I_{O(L)}$	-5	5	uA
	Output High Voltage Level(I_{OH}=-2mA)	V_{OH}	2.4	-	V
	Output Low Voltage Level(I_{OL}=2mA)	V_{OL}	-	0.4	V
5V	Input Leakage Current (Any input 0≤V_{IN}≤V_{IN}+0.5V, all other input pins not under test=0 Volt)	$I_{I(L)}$	-5	5	uA
	Output Leakage Current (Data out is disabled, 0V≤V_{OUT}≤V_{CC})	$I_{O(L)}$	-5	5	uA
	Output High Voltage Level(I_{OH}=-5mA)	V_{OH}	2.4	-	V
	Output Low Voltage Level(I_{OL}=4.2mA)	V_{OL}	-	0.4	V

DC AND OPERATING CHARACTERISTICS (Continued)

Symbol	Power	Speed	Max		Units
			KM41V16000C	KM41C16000C	
I_{CC1}	Don't care	-5 -6	90 80	90 80	mA mA
I_{CC2}	Normal L	Don't care	1 1	2 1	mA mA
I_{CC3}	Don't care	-5 -6	90 80	100 90	mA mA
I_{CC4}	Don't care	-5 -6	90 80	90 80	mA mA
I_{CC5}	Normal L	Don't care	0.5 200	1 250	mA uA
I_{CC6}	Don't care	-5 -6	90 80	100 90	mA mA
I_{CC7}	L	Don't care	200	300	uA
I_{CCS}	L	Don't care	150	250	uA

I_{CC1}* : Operating Current ($\overline{RAS}$ and $\overline{CAS}$ cycling @t_{RC}=min.)

I_{CC2} : Standby Current ($\overline{RAS}$=$\overline{CAS}$=$\overline{W}$=V_{IH})

I_{CC3}* : $\overline{RAS}$-only Refresh Current ($\overline{CAS}$=V_{IH}, $\overline{RAS}$ cycling @t_{RC}=min.)

I_{CC4}* : Fast Page Mode Current ($\overline{RAS}$=V_{IL}, $\overline{CAS}$, Address cycling @t_{PC}=min.)

I_{CC5} : Standby Current ($\overline{RAS}$=$\overline{CAS}$=$\overline{W}$=V_{CC}-0.2V)

I_{CC6}* : $\overline{CAS}$-Before-$\overline{RAS}$ Refresh Current ($\overline{RAS}$ and $\overline{CAS}$ cycling @t_{RC}=min.)

I_{CC7} : Battery back-up current, Average power supply current, Battery back-up mode

Input high voltage(V_{IH})=V_{CC}-0.2V, Input low voltage(V_{IL})=0.2V, $\overline{CAS}$=0.2V,

DQ=Don't care, T_{RC}=31.25us(L-ver), T_{RAS}=T_{RAS}min~300ns

I_{CCS} : Self Refresh Current

$\overline{RAS}$=$\overline{CAS}$=0.2V, $\overline{W}$=A0 ~ A11=V_{CC}-0.2V or 0.2V,

D, Q=V_{CC}-0.2V, 0.2V or Open

***Note :** I_{CC1}, I_{CC3}, I_{CC4} and I_{CC6} are dependent on output loading and cycle rates. Specified values are obtained with the output open. I_{CC} is specified as an average current. In I_{CC1}, I_{CC3} and I_{CC6} address can be changed maximum once while $\overline{RAS}$=V_{IL}. In I_{CC4}, address can be changed maximum once within one fast page mode cycle time, t_{PC}.

CAPACITANCE (T_A=25°C, V_{CC}=5V or 3.3V, f=1MHz)

Parameter	Symbol	Min	Max	Units
Input capacitance [D]	C_{IN1}	-	7	pF
Input capacitance [A0 ~ A11]	C_{IN2}	-	5	pF
Input capacitance [$\overline{RAS}$, $\overline{CAS}$, $\overline{W}$, $\overline{OE}$]	C_{IN3}	-	7	pF
Output capacitance [Q]	C_{OUT}	-	7	pF

AC CHARACTERISTICS (0°C≤T_A≤70°C, See note 1,2)

Test condition (5V device) : V_{CC}=5.0V±10%, Vih/Vil=2.4/0.8V, Voh/Vol=2.4/0.4V
Test condition (3.3V device) : V_{CC}=3.3V±0.3V, Vih/Vil=2.0/0.8V, Voh/Vol=2.0/0.8V

Parameter	Symbol	-5		-6		Units	Notes
		Min	Max	Min	Max		
Random read or write cycle time	t_{RC}	90		110		ns	
Read-modify-write cycle time	t_{RWC}	110		130		ns	
Access time from $\overline{RAS}$	t_{RAC}		50		60	ns	3,4,10
Access time from $\overline{CAS}$	t_{CAC}		13		15	ns	3,5
Access time from column address	t_{AA}		25		30	ns	3,10
$\overline{CAS}$ to output in Low-Z	t_{CLZ}	0		0		ns	3
Output buffer turn-off delay	t_{OFF}	0	13	0	15	ns	6
Transition time (rise and fall)	t_T	3	50	3	50	ns	2
$\overline{RAS}$ precharge time	t_{RP}	30		40		ns	
$\overline{RAS}$ pulse width	t_{RAS}	50	10K	60	10K	ns	
$\overline{RAS}$ hold time	t_{RSH}	13		15		ns	
$\overline{CAS}$ hold time	t_{CSH}	50		60		ns	
$\overline{CAS}$ pulse width	t_{CAS}	13	10K	15	10K	ns	
$\overline{RAS}$ to $\overline{CAS}$ delay time	t_{RCD}	20	37	20	45	ns	4
$\overline{RAS}$ to column address delay time	t_{RAD}	15	25	15	30	ns	10
$\overline{CAS}$ to $\overline{RAS}$ precharge time	t_{CRP}	5		5		ns	
Row address set-up time	t_{ASR}	0		0		ns	
Row address hold time	t_{RAH}	10		10		ns	
Column address set-up time	t_{ASC}	0		0		ns	
Column address hold time	t_{CAH}	10		10		ns	
Column address to $\overline{RAS}$ lead time	t_{RAL}	25		30		ns	
Read command set-up time	t_{RCS}	0		0		ns	
Read command hold time referenced to $\overline{CAS}$	t_{RCH}	0		0		ns	8
Read command hold time referenced to $\overline{RAS}$	t_{RRH}	0		0		ns	8
Write command hold time	t_{WCH}	10		10		ns	
Write command pulse width	t_{WP}	10		10		ns	
Write command to $\overline{RAS}$ lead time	t_{RWL}	13		15		ns	
Write command to $\overline{CAS}$ lead time	t_{CWL}	13		15		ns	

AC CHARACTERISTICS (Continued)

Parameter	Symbol	-5		-6		Units	Notes
		Min	Max	Min	Max		
Data set-up time	t_{DS}	0		0		ns	9
Data hold time	t_{DH}	10		10		ns	9
Refresh period (Normal)	t_{REF}		64		64	ms	
Refresh period (L-ver)	t_{REF}		128		128	ms	
Write command set-up time	t_{WCS}	0		0		ns	7
$\overline{CAS}$ to $\overline{W}$ delay time	t_{CWD}	13		15		ns	7
$\overline{RAS}$ to $\overline{W}$ delay time	t_{RWD}	50		60		ns	7
Column address to $\overline{W}$ delay time	t_{AWD}	25		30		ns	7
$\overline{CAS}$ precharge to $\overline{W}$ delay time	t_{CPWD}	30		35		ns	
$\overline{CAS}$ set-up time ($\overline{CAS}$ -before-$\overline{RAS}$ refresh)	t_{CSR}	5		5		ns	
$\overline{CAS}$ hold time ($\overline{CAS}$ -before-$\overline{RAS}$ refresh)	t_{CHR}	10		10		ns	
$\overline{RAS}$ to $\overline{CAS}$ precharge time	t_{RPC}	5		5		ns	
Access time from $\overline{CAS}$ precharge	t_{CPA}		30		35	ns	3
Fast Page mode cycle time	t_{PC}	35		40		ns	
Fast Page read-modify-write cycle time	t_{PRWC}	53		60		ns	
$\overline{CAS}$ precharge time (Fast Page cycle)	t_{CP}	10		10		ns	
$\overline{RAS}$ pulse width (Fast Page cycle)	t_{RASP}	50	200K	60	200K	ns	
$\overline{RAS}$ hold time from $\overline{CAS}$ precharge	t_{RHCP}	30		35		ns	
Write command set-up time (Test mode in)	t_{WTS}	10		10		ns	11
Write command hold time (Test mode in)	t_{WTH}	10		10		ns	11
$\overline{W}$ to $\overline{RAS}$ precharge time($\overline{C}$-B-$\overline{R}$ refresh)	t_{WRP}	10		10		ns	
$\overline{W}$ to $\overline{RAS}$ hold time($\overline{C}$-B-$\overline{R}$ refresh)	t_{WRH}	10		10		ns	
$\overline{RAS}$ pulse width ($\overline{C}$-B-$\overline{R}$ self refresh)	t_{RASS}	100		100		us	13,14,15
$\overline{RAS}$ precharge time ($\overline{C}$-B-$\overline{R}$ self refresh)	t_{RPS}	90		110		ns	13,14,15
$\overline{CAS}$ hold time ($\overline{C}$-B-$\overline{R}$ self refresh)	t_{CHS}	-50		-50		ns	13,14,15

TEST MODE CYCLE

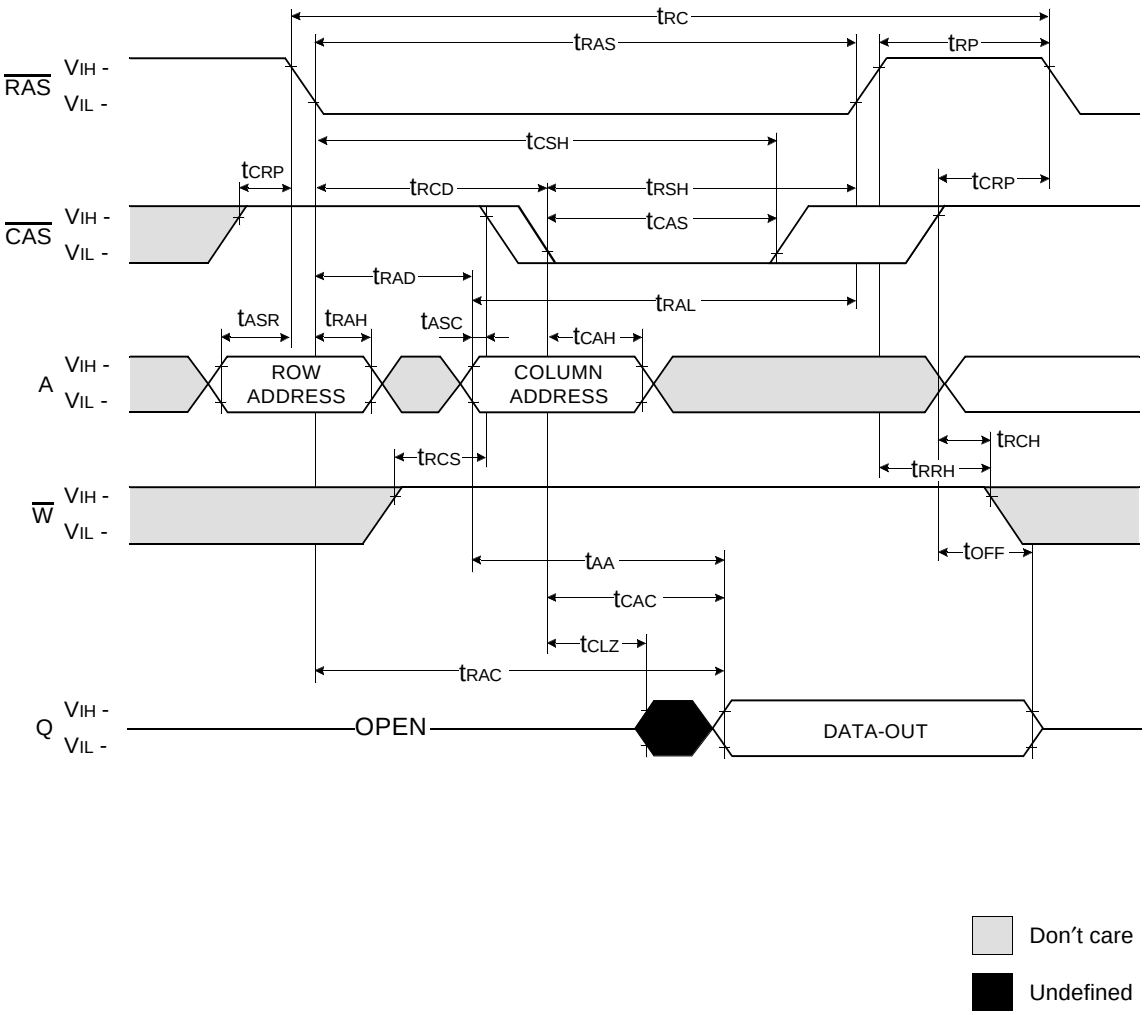
(Note 11)

Parameter	Symbol	-5		-6		Units	Notes
		Min	Max	Min	Max		
Random read or write cycle time	t_{RC}	95		115		ns	
Read-modify-write cycle time	t_{RWC}	115		135		ns	
Access time from $\overline{RAS}$	t_{RAC}		55		65	ns	3,4,10,12
Access time from $\overline{CAS}$	t_{CAC}		18		20	ns	3,5,12
Access time from column address	t_{AA}		30		35	ns	3,10,12
$\overline{RAS}$ pulse width	t_{RAS}	55	10K	65	10K	ns	
$\overline{CAS}$ pulse width	t_{CAS}	18	10K	20	10K	ns	
$\overline{RAS}$ hold time	t_{RSH}	18		20		ns	
$\overline{CAS}$ hold time	t_{CSH}	55		65		ns	
Column address to $\overline{RAS}$ lead time	t_{RAL}	30		35		ns	
$\overline{CAS}$ to $\overline{W}$ delay time	t_{CWD}	18		20		ns	7
$\overline{RAS}$ to $\overline{W}$ delay time	t_{RWD}	55		65		ns	7
Column address to $\overline{W}$ delay time	t_{AWD}	30		35		ns	7
$\overline{CAS}$ precharge to $\overline{W}$ delay time	t_{CPWD}	35		40		ns	
Fast Page mode cycle time	t_{PC}	40		45		ns	
Fast Page read-modify-write cycle time	t_{PRWC}	58		65		ns	
$\overline{RAS}$ pulse width (Fast Page cycle)	t_{RASP}	55	200K	65	200K	ns	
Access time from $\overline{CAS}$ precharge	t_{CPA}		35		40	ns	3

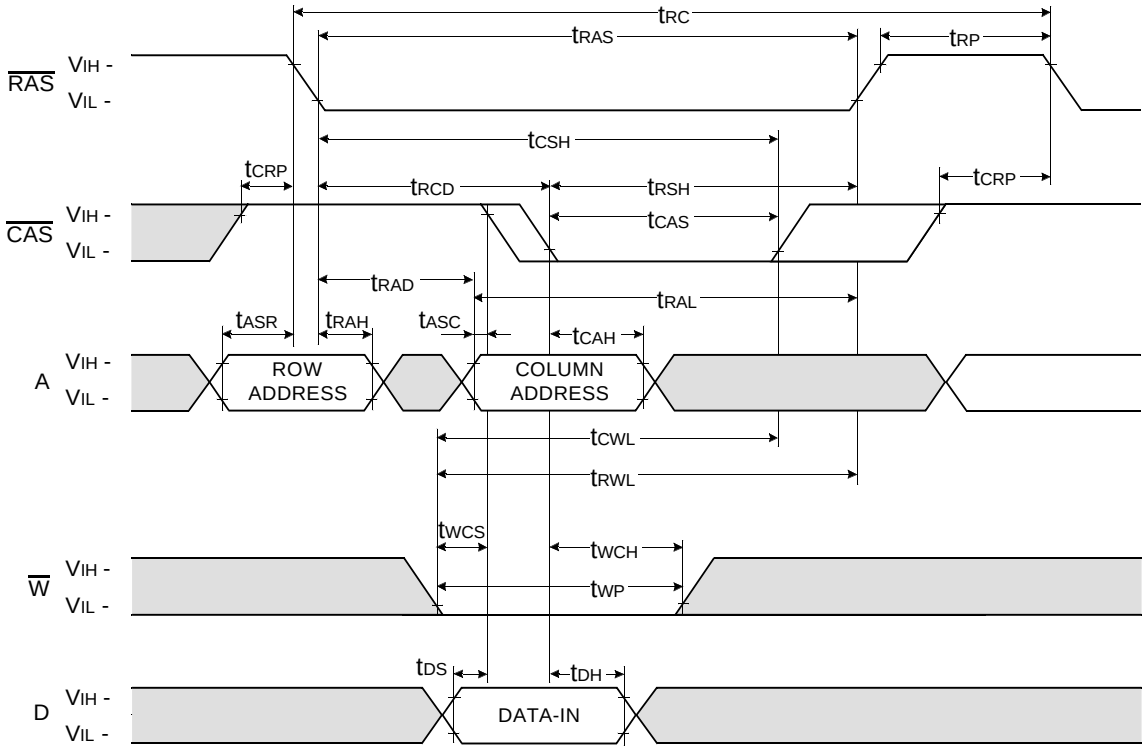
NOTES

1. An initial pause of 200us is required after power-up followed by any 8 $\overline{RAS}$-only refresh or $\overline{CAS}$-before-$\overline{RAS}$ refresh cycles before proper device operation is achieved.
2. V_{IH}(min) and V_{IL}(max) are reference levels for measuring timing of input signals. Transition times are measured between V_{IH}(min) and V_{IL}(max) and are assumed to be 5ns for all inputs.
3. Measured with a load equivalent to 2 TTL(5V)/1 TTL(3.3V) loads and 100pF.
4. Operation within the t_{RCD}(max) limit insures that t_{RAC}(max) can be met. t_{RCD}(max) is specified as a reference point only. If t_{RCD} is greater than the specified t_{RCD}(max) limit, then access time is controlled exclusively by t_{CAC}.
5. Assumes that $t_{RCD} \geq t_{RCD}$(max).
6. t_{OFF}(min)and t_{OEZ}(max) define the time at which the output achieves the open circuit condition and are not referenced V_{oh} or V_{ol}.
7. t_{WCS}, t_{RWD}, t_{CWD} and t_{AWD} are non restrictive operating parameters. They are included in the data sheet as electrical characteristics only. If $t_{WCS} \geq t_{WCS}$(min), the cycle is an early write cycle and the data output will remain high impedance for the duration of the cycle. If $t_{CWD} \geq t_{CWD}$(min), $t_{RWD} \geq t_{RWD}$(min) and $t_{AWD} \geq t_{AWD}$(min), then the cycle is a read-modify-write cycle and the data output will contain the data read from the selected address. If neither of the above conditions is satisfied, the condition of the data out is indeterminate.
8. Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.
9. These parameters are referenced to $\overline{CAS}$ falling edge in early write cycles and to $\overline{W}$ falling edge in read-modify-write cycles.
10. Operation within the t_{RAD}(max) limit insures that t_{RAC}(max) can be met. t_{RAD}(max) is specified as a reference point only. If t_{RAD} is greater than the specified t_{RAD}(max) limit, then access time is controlled by t_{AA}.
11. These specifications are applied in the test mode.
12. In test mode read cycle, the value of t_{RAC}, t_{AA}, t_{CAC} is delayed by 2ns to 5ns for the specified values. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.
13. If $t_{RASS} \geq 100$us, then $\overline{RAS}$ precharge time must use t_{RPS} instead of t_{RP}.
14. For $\overline{RAS}$-only refresh and burst $\overline{CAS}$-before-$\overline{RAS}$ refresh mode, 4096(4K) cycles of burst refresh must be executed within 64ms before and after self refresh, in order to meet refresh specification.
15. For distributed $\overline{CAS}$-before-$\overline{RAS}$ with 15.6us interval $\overline{CAS}$-before-$\overline{RAS}$ refresh should be executed with in 15.6us immediately before and after self refresh in order to meet refresh specification.

READ CYCLE



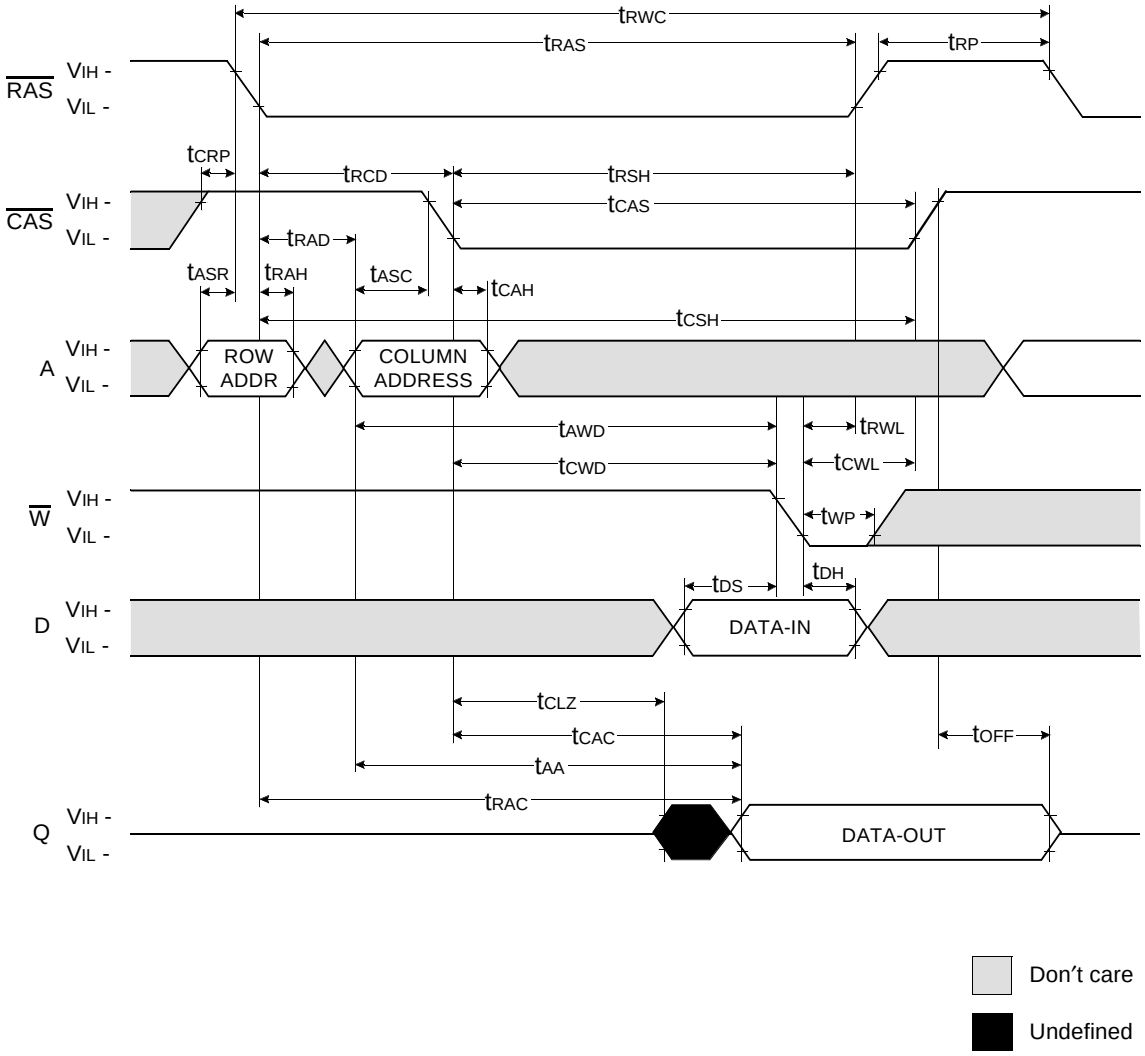
WRITE CYCLE (EARLY WRITE)



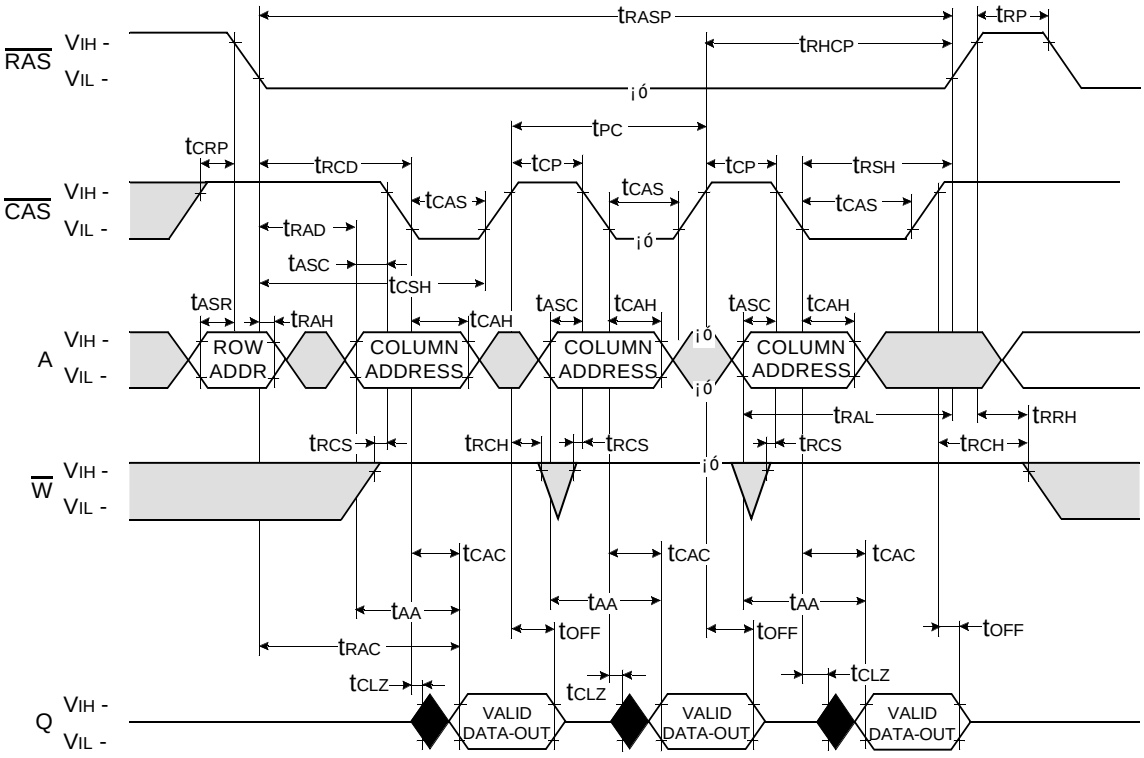
Don't care

Undefined

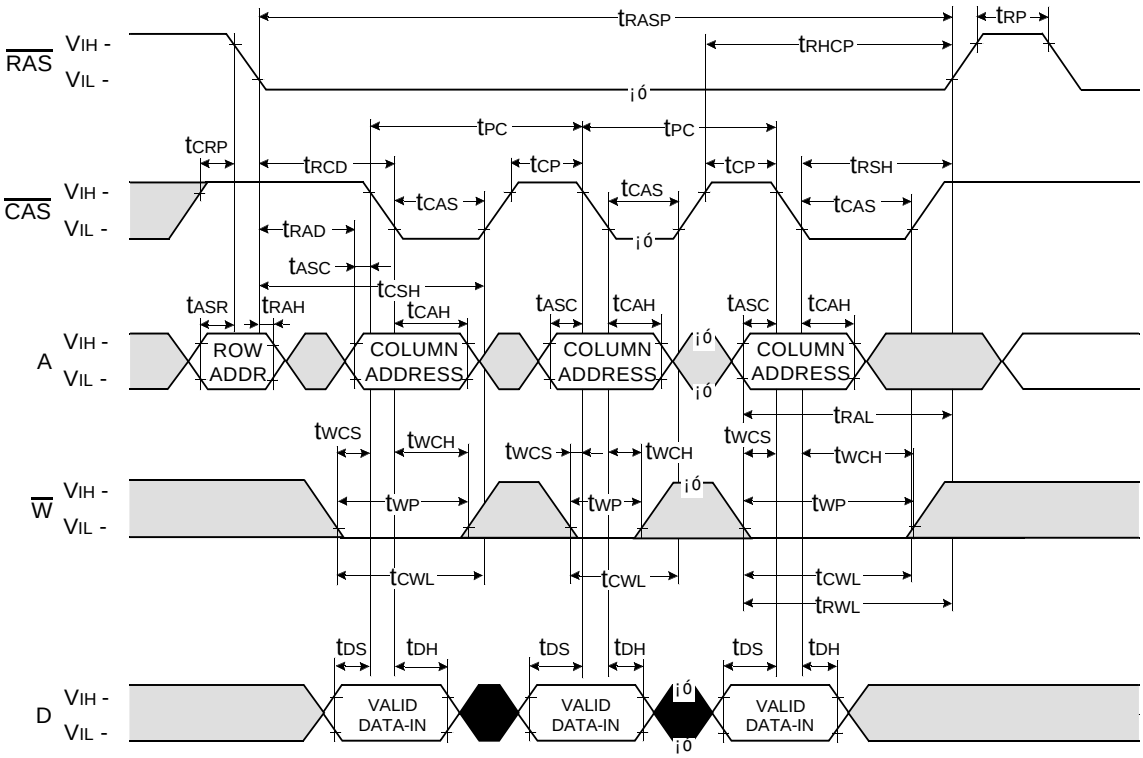
READ-WRITE / READ - MODIFY - WRTIE CYCLE



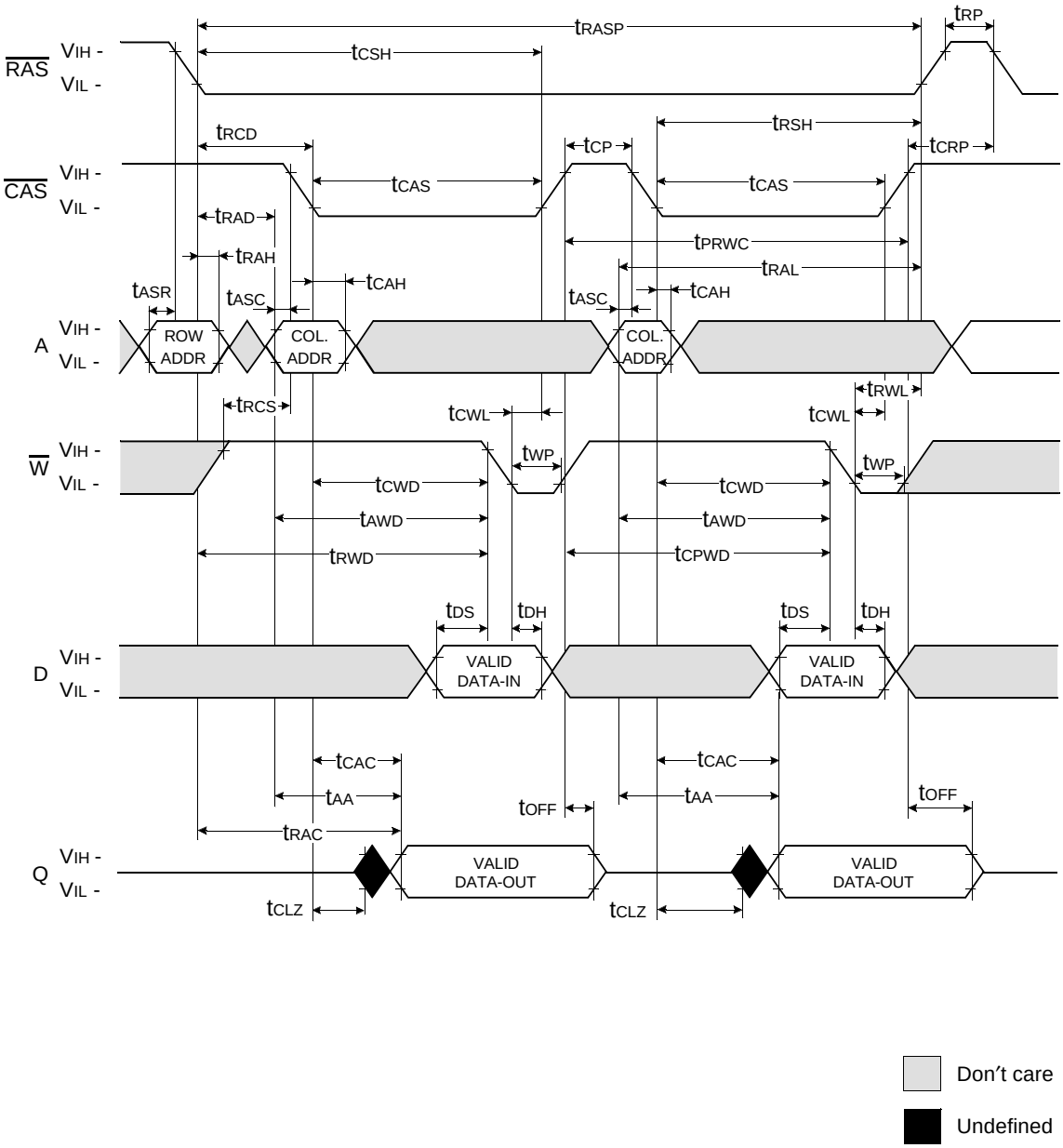
FAST PAGE READ CYCLE



FAST PAGE WRITE CYCLE (EARLY WRITE)



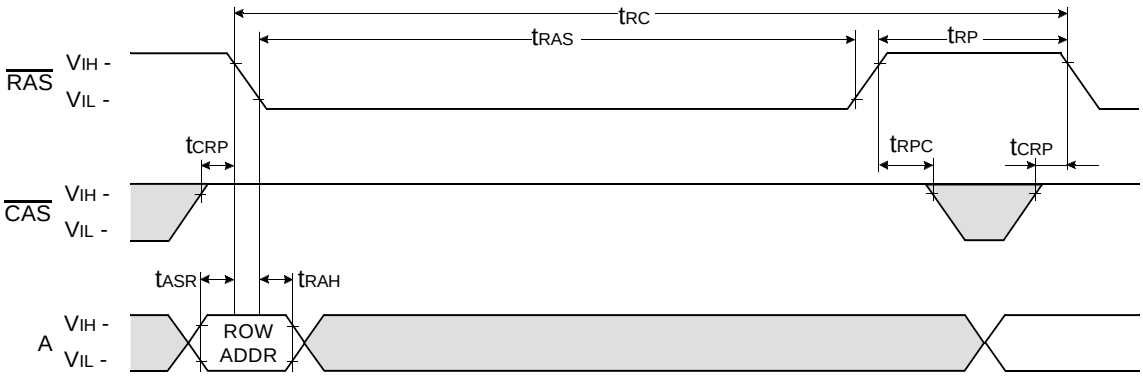
FAST PAGE READ - MODIFY - WRITE CYCLE



$\overline{RAS}$ - ONLY REFRESH CYCLE

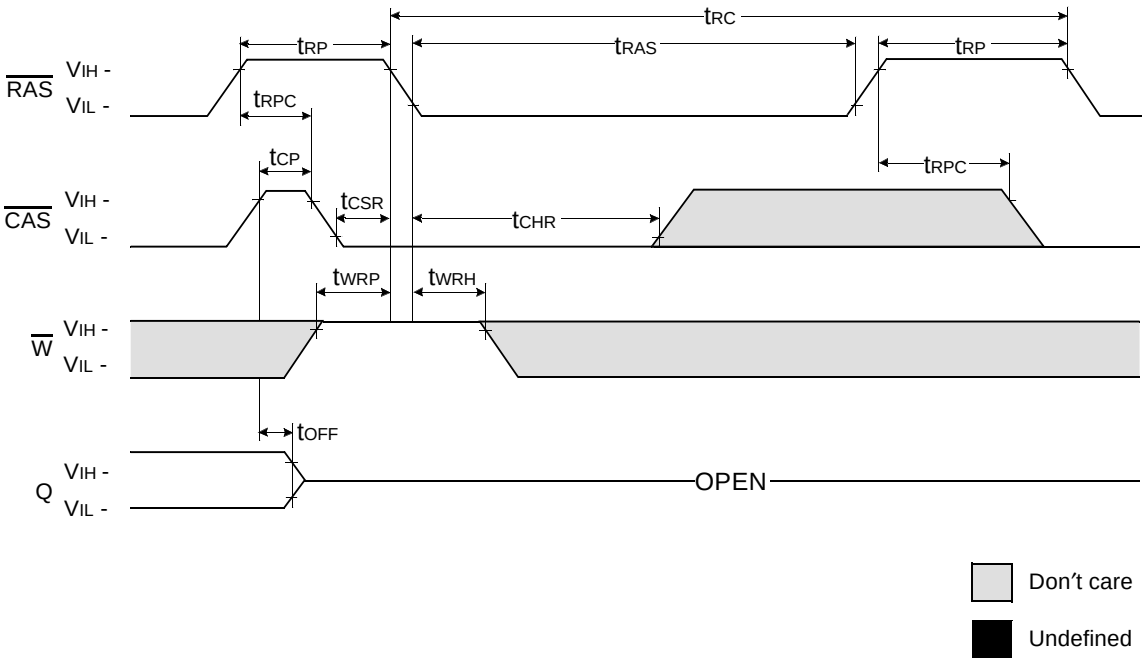
NOTE : $\overline{W}$, D_{IN} = Don't care

D_{OUT} = OPEN

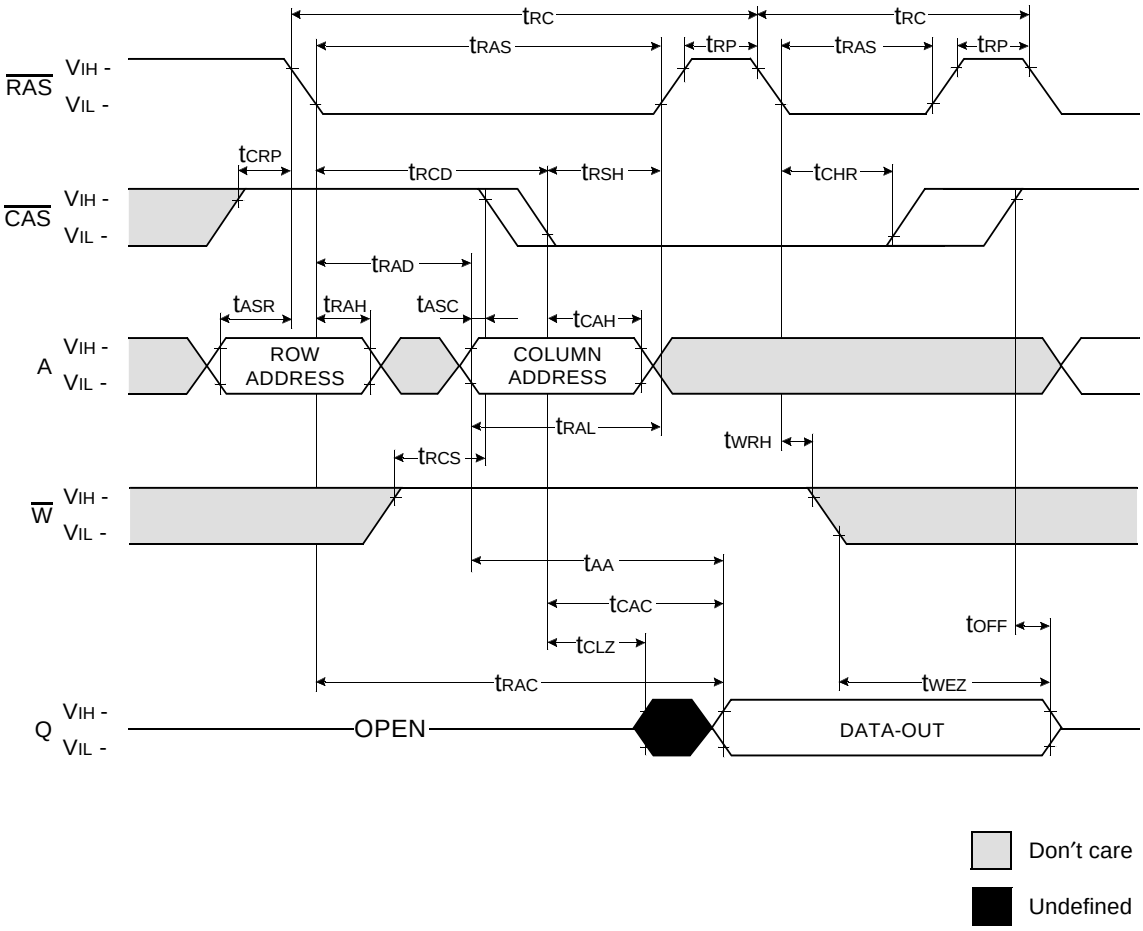


$\overline{CAS}$ - BEFORE - $\overline{RAS}$ REFRESH CYCLE

NOTE : A = Don't care

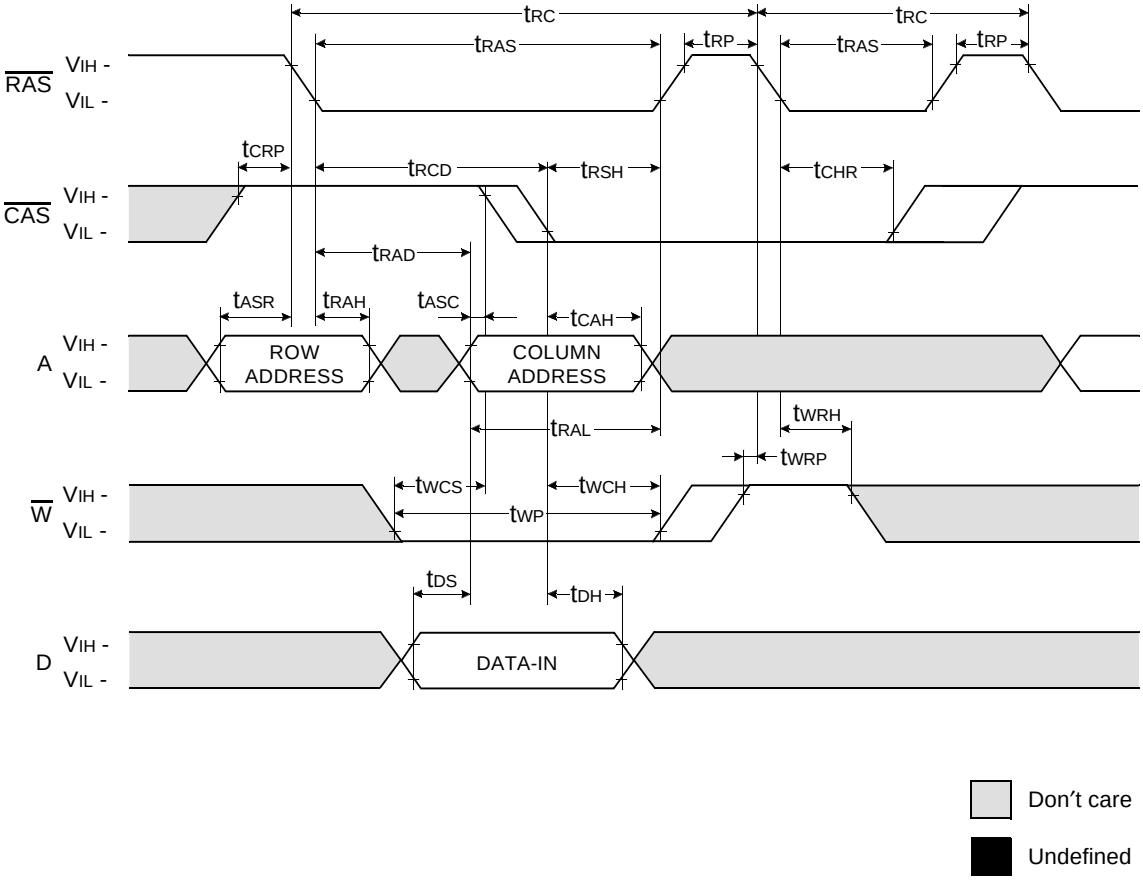


HIDDEN REFRESH CYCLE (READ)



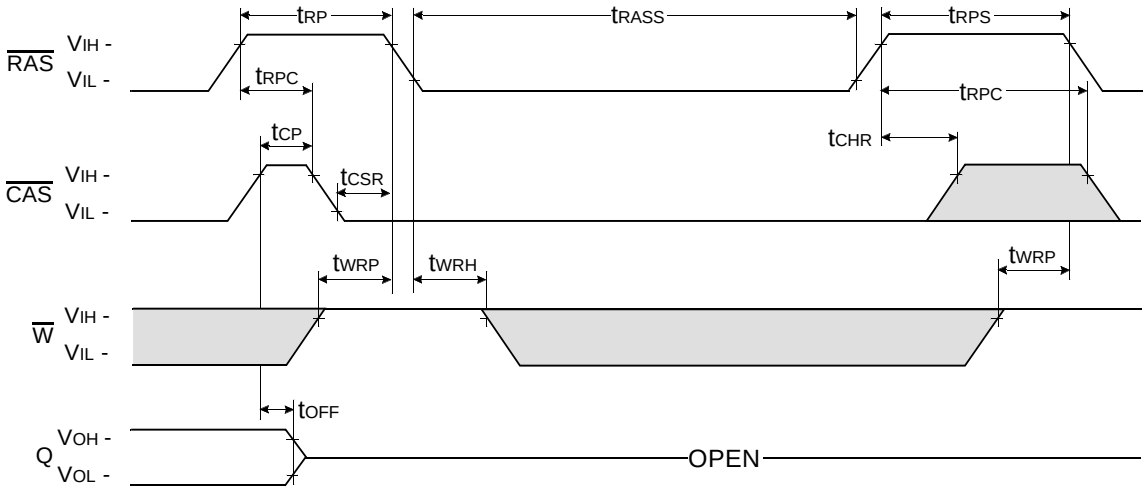
HIDDEN REFRESH CYCLE (WRITE)

NOTE : DOUT = OPEN



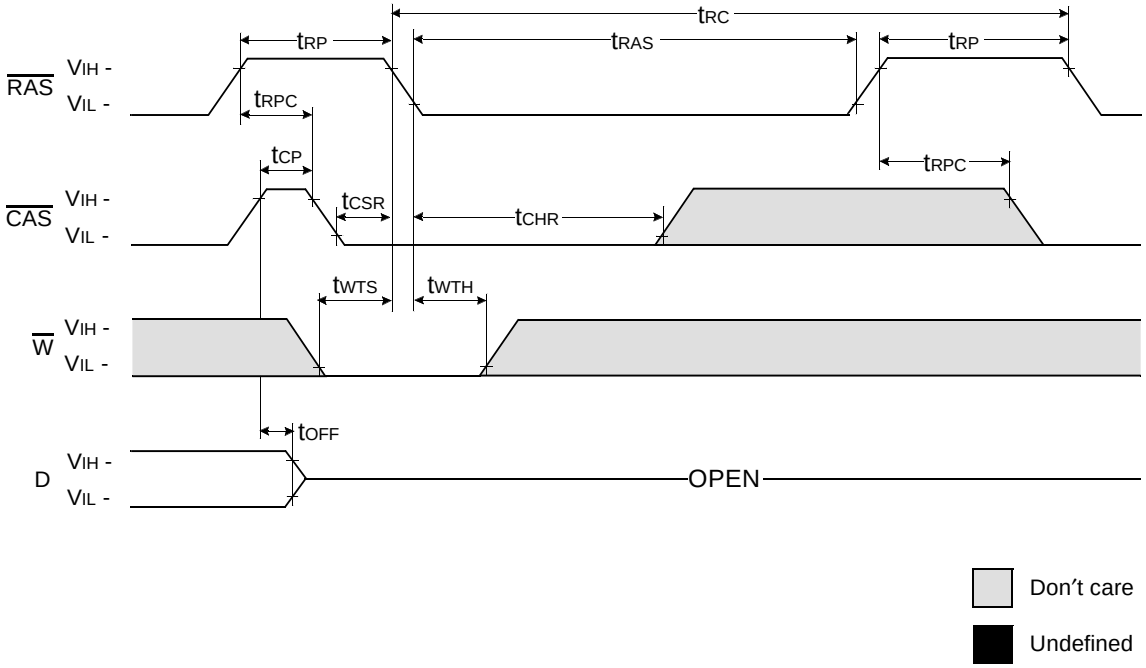
$\overline{CAS}$ - BEFORE - $\overline{RAS}$ SELF REFRESH CYCLE

NOTE : A = Don't care



TEST MODE IN CYCLE

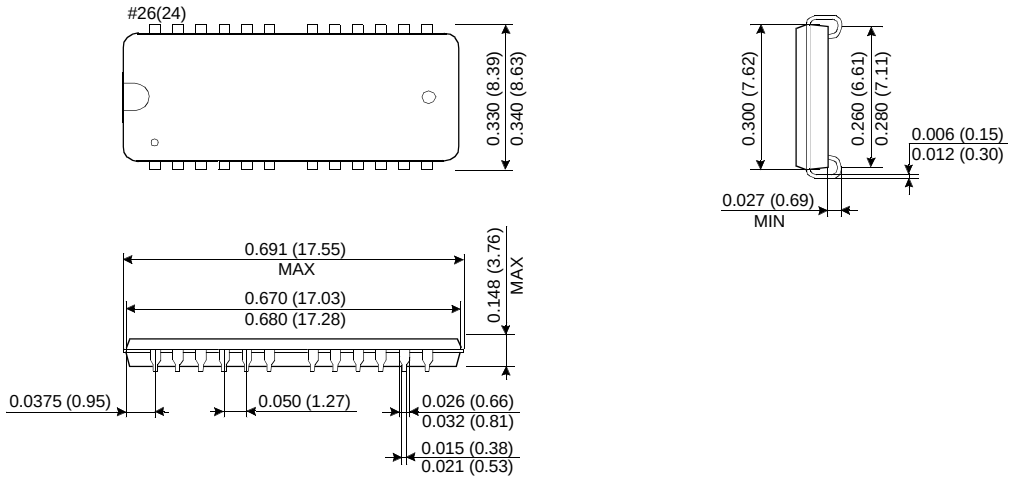
NOTE : D, A = Don't care



PACKAGE DIMENSION

26(24) SOJ 300mil

Units : Inches (millimeters)



26(24) TSOP(II) 300mil

Units : Inches (millimeters)